Electrical Specifications

12

This chapter contains the following electrical and signal information about the R10000 processor:

- DC electrical specification
- AC electrical specification
- signal integrity issues

12.1 DC Electrical Specification

This section describes the following DC electrical characteristics of the R10000 processor:

- DC power supply levels
- DCOk and power supply sequencing
- maximum operating conditions
- input signal level sensing
- mode definitions
- Vref[SC,Sys]
- unused inputs
- DC input/output specifications

DC Power Supply Levels

The processor core is powered by a +3.3V (+/- 5%) supply. The processor output drivers are powered from a separate supply, dependent on the output logic family used in the application system:

- For JEDEC-compatible HSTL operation, the nominal value for VccQSC and VccQSys are in the 1.5V (+/- 100 millivolt) range.
- For CMOS/TTL compatible systems, VccQSC and VccQSys can be externally tied to the same Vcc as the core power supply.

NOTE: The I/O pins of the R10000 processor may not be driven higher than 4.0V by any device in the system until the Vcc and VccQ inputs are stable.

DCOk and Power Supply Sequencing

The following guidelines are designed to protect the processor from damage or latch-up:

- With respect to the Vcc (3.3V) (supply to the core), VccQ[SC,Sys] (either 1.5V or 3.3V) must not be driven more than a diode threshold voltage.
- Vref should not go higher than VccQ[SC,Sys] . Generally, Vref is derived from VccQ through a resistor divider, and therefore cannot rise above VccQ .
- The power to termination resistors must not arrive before Vcc and VccQ[SC,Sys] arrive at the processor.
- None of the supplies can float or be driven negative.

One method of protecting the processor from excessive input voltage is to sequence the power supplies for the entire system, ensuring that the power to the processor is stable before any components drive signals to the processor. Another method to tristate all external drivers to the processor with the DCOk pin, until the processor has stabilized.

NOTE: The input voltage required for the DCOk is 3.3V in either the CMOS/TTL or the HSTL configuration. Both DCOk pins must be tied together externally.

Maximum Operating Conditions

Table 12-1 shows the maximum conditions under which the processor operates.

Table 12-1 Maximum Operating Conditions

Parameter	Symbol	Value
Core Supply Voltage	Vcc	3.6 volts
Output Supply Voltage	VccQ (HTSL) VccQ (CMOS/TTL)	1.6 volts 3.6 volts
Junction Temperature	T_j	20° to 85° C
Applied Input Voltage:	Vin	-0.5 to Vcc+0.5 volts
Maximum Power	P_{R10000}	30 watts
PClk Frequency	f	200 MHz

Input Signal Level Sensing

The processor input signals are all received by CMOS receivers that are compatible with either HSTL or CMOS/TTL logic levels. The I/O levels are defined by VrefSC and VrefSys, according to the appropriate logic family (HSTL or CMOS/TTL).

Mode Definitions

The mode bit, ODrainSys, is provided to select the characteristics of the pad ring.

When asserted, this mode bit tristates the PMOS pullup devices to select system interface output drivers. This mode is included to allow for multiprocessor systems to use a GTL-like open drain configuration with external load/termination resistors providing logic high levels.

Vref[SC,Sys]

The Vref[SC,Sys] pins must be connected to a stable reference voltage source. This reference point is used in the input sense amp current mirror to provide the switch point for the logic levels.

Inside the processor, the Vref[SC,Sys] signals have a large capacitance, and a low-pass filter at each receiver. The DCOk pins must not be asserted until there has been sufficient time for Vref[SC,Sys] to stabilize at each of the receivers inside the processor.

A typical Vref[SC,Sys] generator is two resistors which provide the Vref[SC,Sys] level associated with the chosen logic family, and a 10µF tantalum capacitor connected to the processor's Vref[SC,Sys] pin to provide stability.

Unused Inputs

Several input pins are unused during normal system operation, and should be tied to Vcc through resistors:

- JTDI
- JTCK
- JTMS

Several input pins are unused during normal system operation, and should be tied to Vss through 100 ohm resistors:

- TCA, TCB
- PLLDis
- Spare1, Spare3

Several input pins are unused during normal system operation, and should be tied to Vss:

- PLLSpare1, PLLSpare2, PLLSpare3, PLLSpare4
- SelDVCO

DC Input/Output Specifications

All processor output drivers are CMOS push-pull, and the signals swing between VccQ and Vss . In open drain mode, the gates of the PMOS pullup devices are disabled. Input-only pins include a disabled output buffer for implicit ESD protection.

Tables 12-2 and 12-3 describe the DC characteristics of the I/O signals for the HSTL and CMOS/TLL configurations.

NOTE: As the JEDEC Standard 8-x evolves, the HSTL specifications will also change, and the processor will remain compliant with these standards.

Table 12-2 DC Characteristics for HSTL Configuration

Symbol	Parameter	Minimum	Maximum	Units	Conditions
VOH	Output high voltage	VccQ /2 + 0.3V	N/A	V	N/A
VOL	Output low voltage		VccQ /2 - 0.3V	V	N/A
VIH	Input high voltage	Vref + 100mV	Vcc + 300mV	V	N/A
VIL	Input low voltage	-300mV	Vref - 100mV	V	N/A
ILeak	I/O leakage current	-TBD	TBD	µA	N/A

Table 12-3 DC Characteristics for CMOS/TTL Configuration

Symbol	Parameter	Minimum	Maximum	Units	Conditions
VOH	Output high voltage	2.4	N/A	V	Vcc = VccQ = min
VOL	Output low voltage	N/A	0.4	V	Vcc = VccQ = min
VIH	Input high voltage	2.0	N/A	V	N/A
VIL	Input low voltage	N/A	0.8	V	N/A
ILeak	I/O leakage current	-TBD	TBD	µA	N/A

12.2 AC Electrical Specification

This section describes the following AC electrical characteristics of the R10000 processor:

- maximum operating conditions
- test specification
- secondary cache and system interface timing
- enable/output delay, setup, hold time
- asynchronous inputs

Maximum Operating Conditions

The R10000 chip clamps signals that overshoot the DC limits established for input logic levels. These limits are published as part of the fabrication process characterization.

The R10000 chip provides silicon diode clamps on all signal pins.

Test Specification

HSTL test conditions are based on the JEDEC Standard conditions.

Secondary Cache and System Interface Timing

Timing measurements are referenced from the mid-swing point of the input signal to the crossing point of the SysClk and SysClk* input clocks. All input signals maintain a 1 V/ns edge rate in the 20% to 80% range of the input signal swing.

Enable/Output Delay, Setup, Hold Time

Table 12-4 lists the delay, setup, and hold times for the HTSL version of the processor.

Table 12-4 AC Characteristics for HSTL Configuration

HSTL	Minimum	Maximum
Output delay	0.5 ns	1.5 ns
Setup	1.0 ns	
Hold	1.0 ns	

Table 12-5 lists the delay, setup, and hold times for the CMOS/TTL version of the processor.

Table 12-5 AC Characteristics for CMOS/TTL Configuration

LVCMOS	Minimum	Maximum
Output delay	0.5 ns	2.0 ns
Setup	1.0 ns	
Hold	1.0 ns	

Asynchronous Inputs

The SysReset* input can be asserted asynchronously to SysClk, but must be negated synchronously with SysClk, adhering to the AC electrical specifications listed above.

12.3 Signal Integrity Issues

In this section, the following signal integrity considerations are described for a R10000-based system:

- Power Supply Regulation
- Decoupling Capacitance
- Reference Voltage
- Maximum Input Voltage Levels
- Output I-V Curves
- Switching and Slew Rate Characteristics

Reference Voltage

Most input pins on the processor use a current-mirror sense amp with Vref[SC,Sys] supplied to the negative input to provide a single rail input receiver. The following input pins are exceptions to this rule:

- SysClk and SysClk*
- DCOk

All other inputs require a stable Vref[SC,Sys] supply for proper operation.

The Vref[SC,Sys] source can be a simple voltage divider; the actual impedance of this source is not critical, since the Vref[SC,Sys] signals are sampled through a low-pass filter on the processor.

Power Supply Regulation

The system must provide connections to all of the Vcc , VccQ[SC,Sys] , and Vss pins on the processor package. The power supply voltages must be held to 5% tolerance at the processor pin connection.

Maximum Input Voltage Levels

Maximum excursion of the input signal due to ringing may reach Vcc+0.5V or Vss-0.5V for periods of less than 10% of the total driven waveform period. The R10000 processor includes overshoot clamps by silicon diode protection which limit the overshoot to approximately 500 mV beyond each supply rail.

Decoupling Capacitance

In order to regulate the transient current requirements of a R10000-based system, it is suggested that explicit decoupling capacitors be used. The R10000 package allows for the following capacitors:

- eight Vcc -Vss
- six VccQSC-Vss
- two VccQSys-Vss

The package also provides six connections for the PLL power supplies and loop capacitors.

VccPa (VccPd) is connected to VssPa (VssPd) through three decoupling capacitors, as shown in Figures 12-1 and 12-2. The 0.1µF and 1 nF low-inductance capacitors are placed in parallel with the 10 µF capacitor, as close to the R10000 package as possible.†

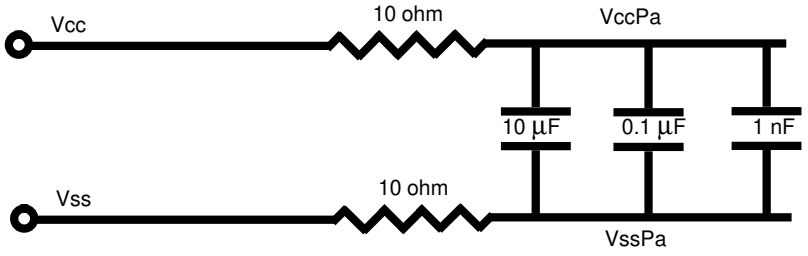

Figure 12-1 Decoupling VccPa and VssPa

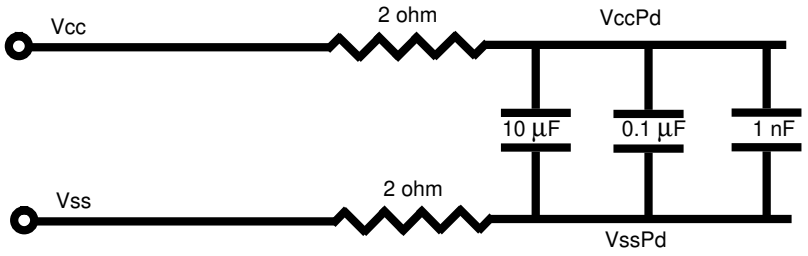

Figure 12-2 Decoupling VccPd and VssPd

Output I-V Curves

Not yet available

Switching and Slew Rate Characteristics

Not yet available

† Decoupling between VccPa and VssPa is far more important than decoupling between VccPd and VssPd, if both are not possible.